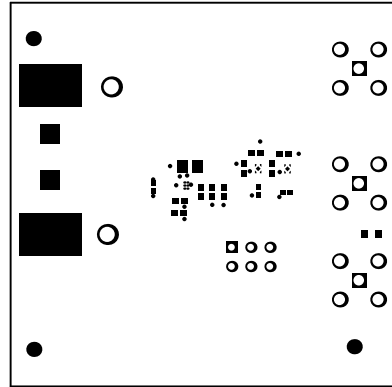
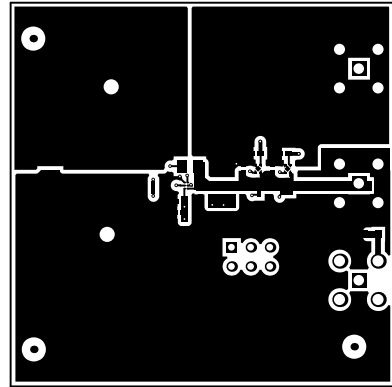


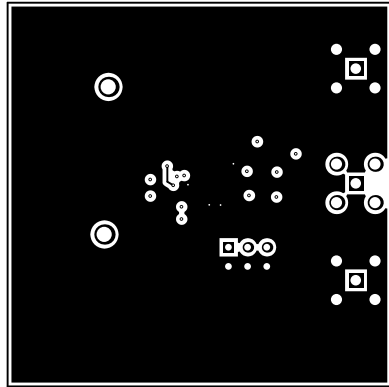
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Overlay			
PLOT NAME = Top Overlay	GENERATED : 11/23/2015 7:06:44 PM	TEXAS INSTRUMENTS	



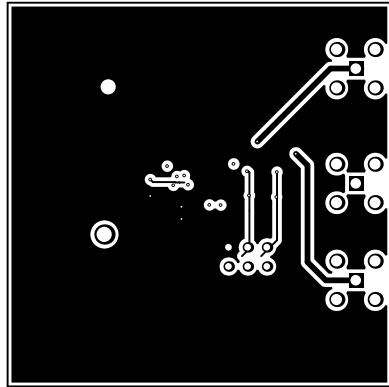
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Top Solder			
PLOT NAME = Top Solder Mask	GENERATED : 11/23/2015 7:06:45 PM	TEXAS INSTRUMENTS	



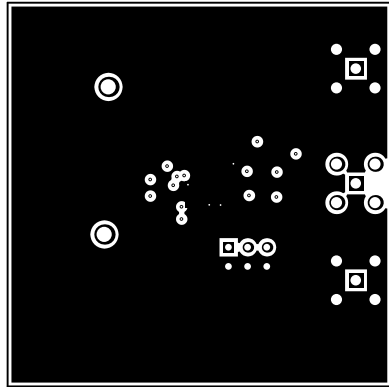
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME = L1(TOP)			
PLOT NAME = Top Layer	GENERATED : 11/23/2015 7:06:46 PM	TEXAS INSTRUMENTS	



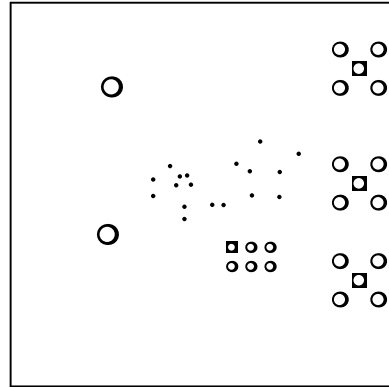
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Signal Layer 1	GENERATED : 11/23/2015 7:06:46 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME =			
PLOT NAME = Signal Layer 2	GENERATED : 11/23/2015 7:06:47 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME = L4(BOT)			
PLOT NAME = Bottom Layer	GENERATED : 11/23/2015 7:06:47 PM	TEXAS INSTRUMENTS	



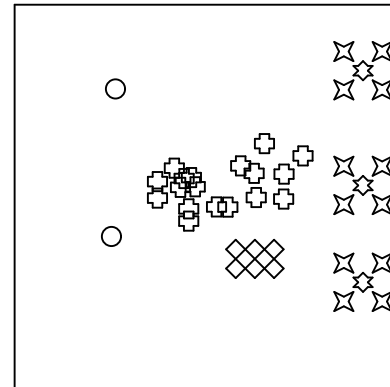
ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Solder			
PLOT NAME = Bottom Solder Mask	GENERATED : 11/23/2015 7:06:48 PM	TEXAS INSTRUMENTS	



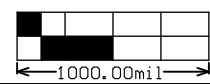
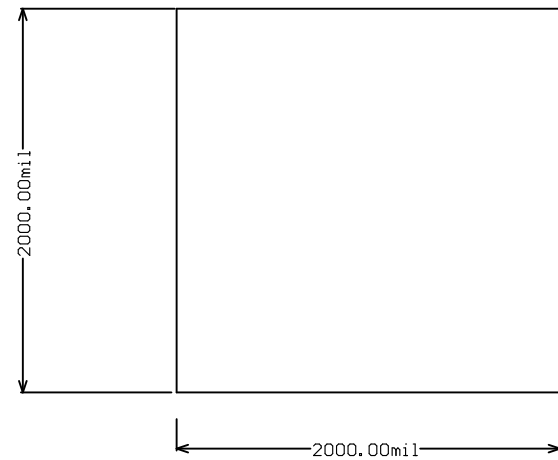
For evaluation only; not FCC approved for resale.

ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Bottom Overlay			
PLOT NAME = Bottom Overlay	GENERATED : 11/23/2015 7:06:49 PM	TEXAS INSTRUMENTS	

Symbol	Quantity	Finished Hole Size	Plated	Hole Type
⊕	18	10.00mil (0.254mm)	PTH	Round
◇	6	35.43mil (0.900mm)	PTH	Round
✱	3	55.12mil (1.400mm)	PTH	Round
✱	12	59.06mil (1.500mm)	PTH	Round
○	2	80.71mil (2.050mm)	PTH	Round
41 Total				



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME = Drill Drawing			
PLOT NAME = Drill Drawing	GENERATED : 11/23/2015 7:06:49 PM	TEXAS INSTRUMENTS	



ALL ARTWORK VIEWED FROM TOP SIDE	BOARD #: TIDA-00718	REV: A	SUN REV: Not In VersionControl
LAYER NAME = M2 Board Dimensions			
PLOT NAME = Board Dimensions	GENERATED : 11/23/2015 7:06:50 PM	TEXAS INSTRUMENTS	

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